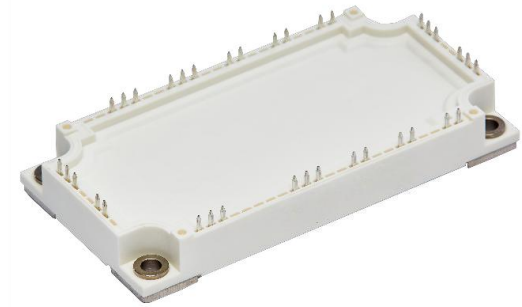


**EconoPIM3 SixPack IGBT Module**

$V_{CES}= 1200V, I_C= 150A, V_{CE(sat)}= 1.53V$

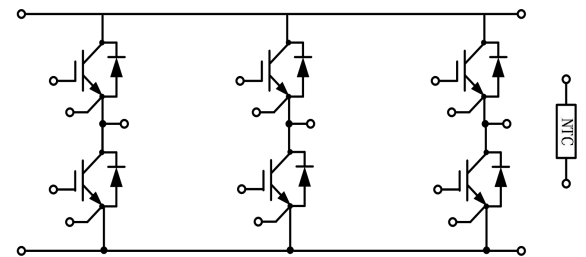
**Features**

- 1200V Trench Gate/Field Termination Process
- Low Switching Losses
- $V_{CE(sat)}$  With Positive Temperature Coefficient
- Integrated NTC Temperature Sensor



**Applications**

- Power Conversion System
- Inverter
- Servo Drives



**IGBT, Inverter**  
**Maximum Ratings**

Parameter	Symbol	Condition	Value	Unit
Collector-emitter voltage	$V_{CES}$	$T_{vj}=25^{\circ}C, V_{GE}=0V$	1200	V
Continuous DC collector current	$I_{C\ nom}$	$T_C=100^{\circ}C, T_{vj\ max}=175^{\circ}C$	150	A
Repetitive peak collector current	$I_{CRM}$	$t_P=1ms$	300	A
Gate-emitter peak voltage	$V_{GES}$	$T_{vj}=25^{\circ}C$	$\pm 20$	V

**Characteristics Values**

Parameter	Symbol	Conditions	Value			Unit	
			Min.	Typ.	Max.		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=150A, V_{GE}=15V$	$T_{vj}=25^{\circ}C$	1.53	2.1	V	
			$T_{vj}=125^{\circ}C$	1.75		V	
			$T_{vj}=150^{\circ}C$	1.81		V	
Gate-emitter threshold voltage	$V_{GE(th)}$	$I_C=5.3mA, V_{CE}=V_{GE}$	$T_{vj}=25^{\circ}C$	5.2	5.8	6.4	V
Gate charge	$Q_G$	$V_{GE}=-15V...+15V$		1.56			$\mu C$
Integrated gate resistor	$R_{G\ int}$	$T_{vj}=25^{\circ}C$		1.1			$\Omega$
Input capacitance	$C_{ies}$	$f=100KHz, V_{CE}=25V, V_{GE}=0V$	$T_{vj}=25^{\circ}C$	23.82			nF
Reverse transfer capacitance	$C_{res}$	$f=100KHz, V_{CE}=25V, V_{GE}=0V$	$T_{vj}=25^{\circ}C$	0.22			nF
Collector-emitter cut-off current	$I_{CES}$	$V_{CE}=1200V, V_{GE}=0V$	$T_{vj}=25^{\circ}C$			1	mA
Gate-emitter leakage current	$I_{GES}$	$V_{CE}=0V, V_{GE}=20V$	$T_{vj}=25^{\circ}C$			100	nA

Turn-on delay time	$t_{d\ on}$	$I_C=150A, V_{CE}=600V, V_{GE}=-15V/+15V, R_G=5\Omega, \text{Inductive Load}$	$T_{vj}=25^\circ C$	102	ns
			$T_{vj}=125^\circ C$	103	ns
			$T_{vj}=150^\circ C$	104	ns
Rise time	$t_r$	$I_C=150A, V_{CE}=600V, V_{GE}=-15V/+15V, R_G=5\Omega, \text{Inductive Load}$	$T_{vj}=25^\circ C$	47	ns
			$T_{vj}=125^\circ C$	55	ns
			$T_{vj}=150^\circ C$	56	ns
Turn-off delay time	$t_{d\ off}$	$I_C=150A, V_{CE}=600V, V_{GE}=-15V/+15V, R_G=5\Omega, \text{Inductive Load}$	$T_{vj}=25^\circ C$	337	ns
			$T_{vj}=125^\circ C$	381	ns
			$T_{vj}=150^\circ C$	397	ns
Fall time	$t_f$	$I_C=150A, V_{CE}=600V, V_{GE}=-15V/+15V, R_G=5\Omega, \text{Inductive Load}$	$T_{vj}=25^\circ C$	180	ns
			$T_{vj}=125^\circ C$	257	ns
			$T_{vj}=150^\circ C$	275	ns
Turn-on energy loss per pulse	$E_{on}$	$I_C=150A, V_{CE}=600V, V_{GE}=-15V/+15V, R_G=5\Omega, di/dt=2150A/\mu s (T_{vj}=150^\circ C) \text{ Inductive Load}$	$T_{vj}=25^\circ C$	11.09	mJ
			$T_{vj}=125^\circ C$	19.92	mJ
			$T_{vj}=150^\circ C$	22.71	mJ
Turn-off energy loss per pulse	$E_{off}$	$I_C=100A, V_{CE}=600V, V_{GE}=-15V/+15V, R_G=2\Omega, du/dt=4250V/\mu s (T_{vj}=150^\circ C) \text{ Inductive Load}$	$T_{vj}=25^\circ C$	10.18	mJ
			$T_{vj}=125^\circ C$	13.54	mJ
			$T_{vj}=150^\circ C$	14.45	mJ
SC data	$I_{SC}$	$V_{GE}\leq 15V, V_{CE}=800V, V_{CEmax}=V_{CES}-L_{sCE} * di/dt, t_p\leq 10\mu s,$	$T_{vj}=150^\circ C$	730	A
Temperature under switching conditions	$T_{vj\ op}$		-40	150	$^\circ C$

### Diode, Inverter Maximum Ratings

Parameter	Symbol	Conditions	Value	Unit
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj}=25^\circ C$	1200	V
Continuous forward current	$I_F$		150	A
Repetitive peak forward current	$I_{FRM}$	$t_p=1ms$	300	A
$I^2t$ -value	$I^2t$	$t_p=10ms, \sin 180^\circ$	$T_{vj}=125^\circ C$	8000 $A^2s$

### Characteristics Values

Parameter	Symbol	Conditions	Values			Units
			Min.	Typ.	Max.	
Forward voltage	$V_F$	$I_F=150A, V_{GE}=0V$	$T_{vj}=25^\circ C$	2.05	2.4	V
			$T_{vj}=125^\circ C$	1.75		V
			$T_{vj}=150^\circ C$	1.67		V
Peak reverse recovery current	$I_{rr}$	$I_F=150A, V_R=600V, V_{GE}=-15V, -di_F/dt=2150A/\mu s (T_{vj}=150^\circ C)$	$T_{vj}=25^\circ C$	138		A
			$T_{vj}=125^\circ C$	189		A
			$T_{vj}=150^\circ C$	198		A

Recovered charge	$Q_{rr}$	$I_F=150A,$ $V_R=600V,$ $V_{GE}=-15V,$ $-diF/dt=2150A/\mu s$ $(T_{vj}=150^\circ C)$	$T_{vj}=25^\circ C$		11.67		$\mu C$
			$T_{vj}=125^\circ C$		29.77		$\mu C$
			$T_{vj}=150^\circ C$		35.09		$\mu C$
Reverse recovery energy	$E_{rec}$		$T_{vj}=25^\circ C$		3.37		mJ
			$T_{vj}=125^\circ C$		9.26		mJ
			$T_{vj}=150^\circ C$		11.07		mJ
Temperature under switching conditions	$T_{vj\ op}$		-40		150	$^\circ C$	

**NTC-Thermistor**  
**Characteristics Values**

Parameter	Symbol	Conditions	Value			Unit
			Min.	Typ.	Max.	
Rated resistance	R25	$T_C=25^\circ C, \pm 5\%$		5.0		k $\Omega$
B-value	B25/50	$\pm 1\%$		3380		K

**Module**  
**Characteristics Values**

Parameter	Symbol	Conditions	Values			Units
			Min.	Typ.	Max.	
Isolation test voltage	$V_{ISOL}$	RMS, f=50Hz, t=1min		2.5		kV
Internal isolation	-		$Al_2O_3$			-
Storage temperature	$T_{stg}$		-40		125	$^\circ C$
Mounting torque for module mounting	M		3	-	6	N·m
Weight	G			300		g

### Typical Characteristics

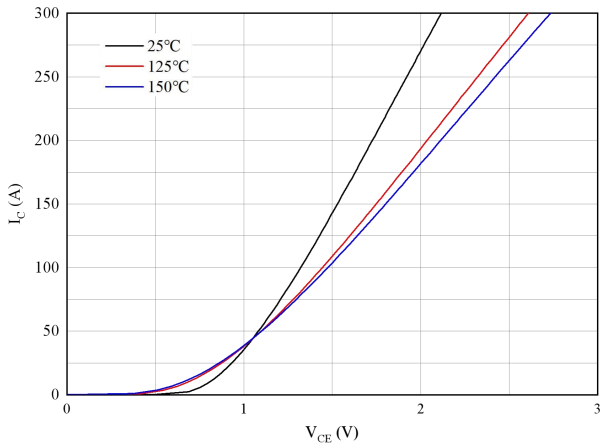


Fig 1. Output characteristics of IGBT, Inverter

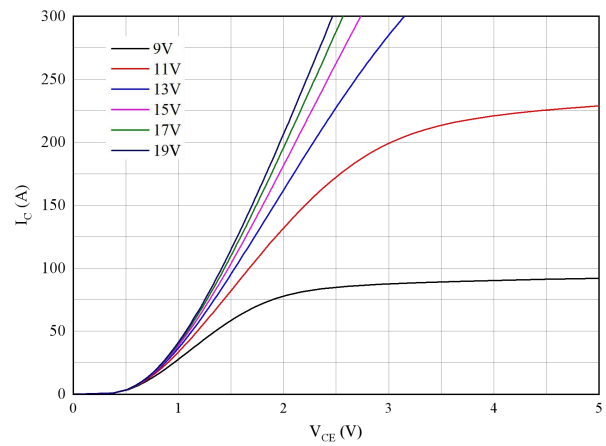


Fig 2. Output characteristics of IGBT, Inverter

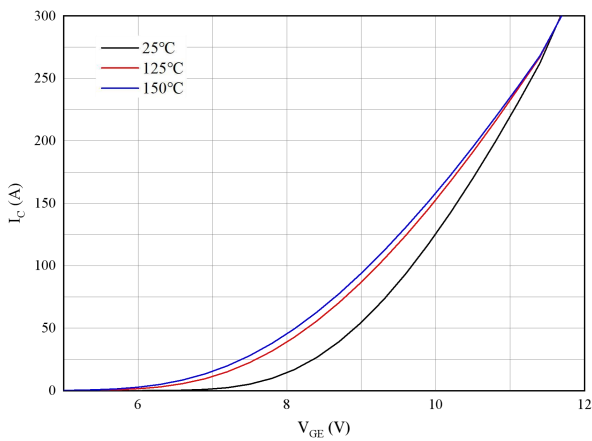


Fig 3. Transfer characteristics of IGBT, Inverter

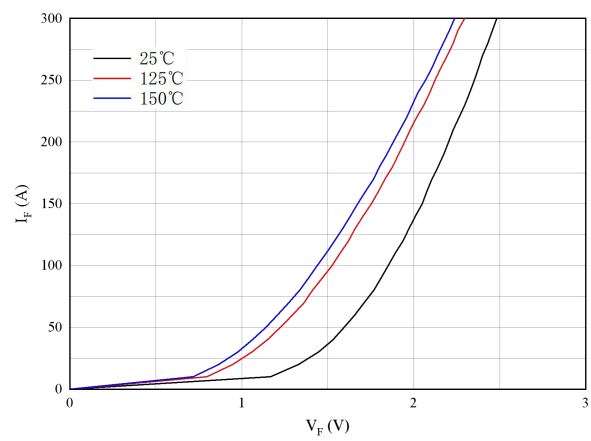


Fig 4. Forward characteristics of Diode

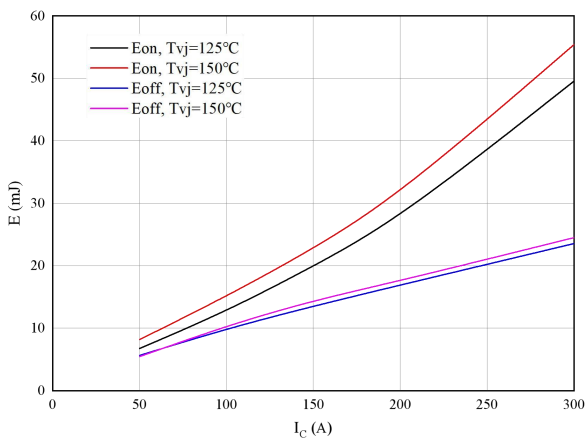


Fig 5. Switching losses of IGBT,  
 $V_{GE} = \pm 15V$ ,  $R_{Gon} = R_{Goff} = 5\Omega$ ,  $V_{CE} = 600V$

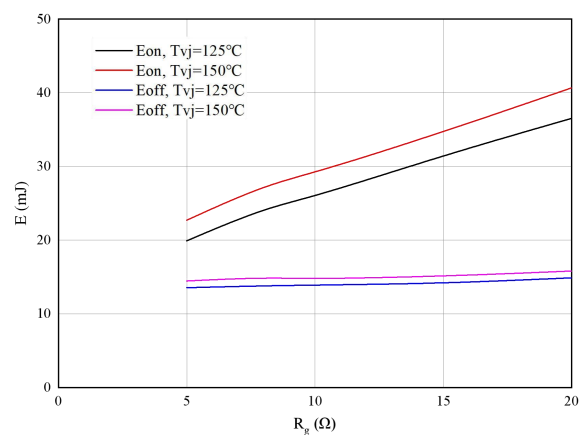
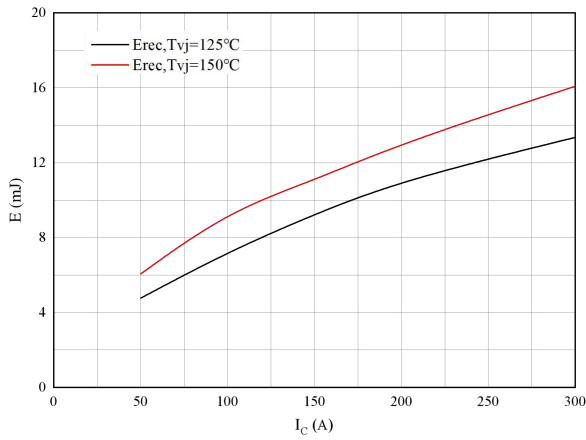
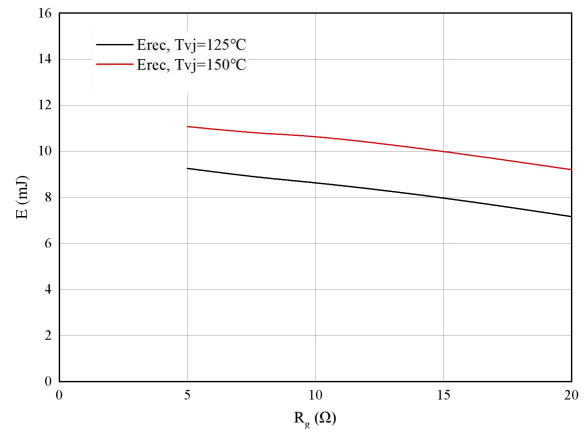


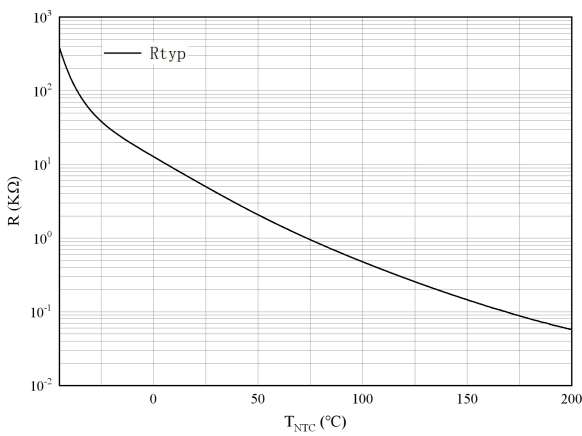
Fig 6. Switching losses of IGBT,  
 $V_{GE} = \pm 15V$ ,  $I_C = 150A$ ,  $V_{CE} = 600V$



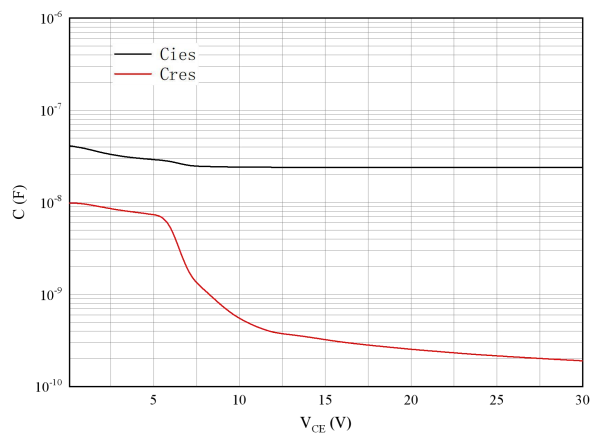
**Fig 7. Switching losses of Diode**  
 $R_{Gon}=R_{Goff}=5\Omega, V_{CE}=600V$



**Fig 8. Switching losses of Diode**  
 $I_F=150A, V_{CE}=600V$

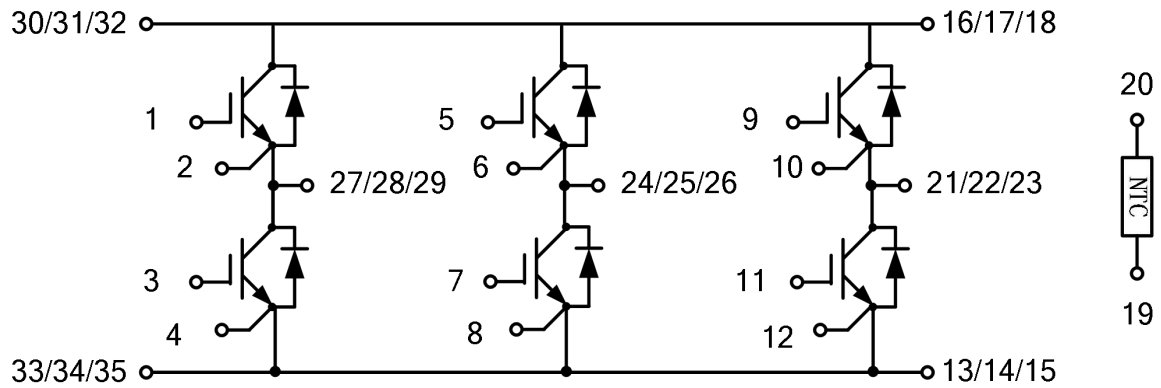


**Fig 9. NTC-Themistor-temperature characteristic**

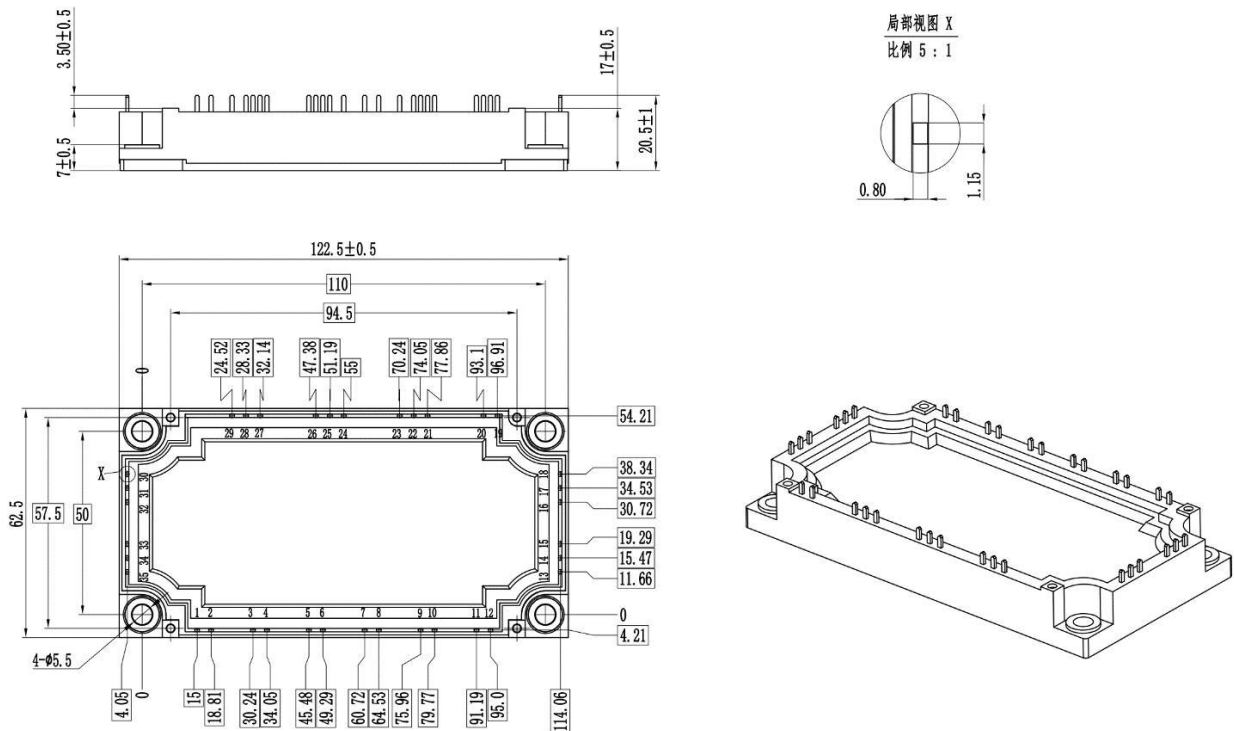


**Fig 10. Capacitance characteristics**

### Circuit Diagram



### Package Outlines (Unit:mm)



**\*Important Usage Information and Disclaimer**

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